

CC1A-T1AH up to 200°C

CC1A-T1AH up to 200°C

AT-Cut **Quartz Crystal Unit** 8 MHz – 24 MHz

2. Product Description

The CC1A-T1AH is a high frequency SMT Quartz Crystal Unit that incorporates an AT-Cut Quartz Crystal Resonator. The Quartz Crystal Resonator operates under vacuum condition in a hermetically sealed ceramic package with ceramic lid.

Suitable oscillator-circuitries can operate the CC1A-T1AH Quartz Crystal Units in fundamental mode in the frequency range of 8 MHz – 24 MHz. For technical assistance for optimizing oscillator-circuitries please contact Micro Crystal under <u>sales@microcrystal.com</u>

2.1. Application Examples

Telemetry Optical Network Airborne Equipment Geothermal Equipment Radio Communications Down Hole and Well Drilling

2.2. Ordering Information

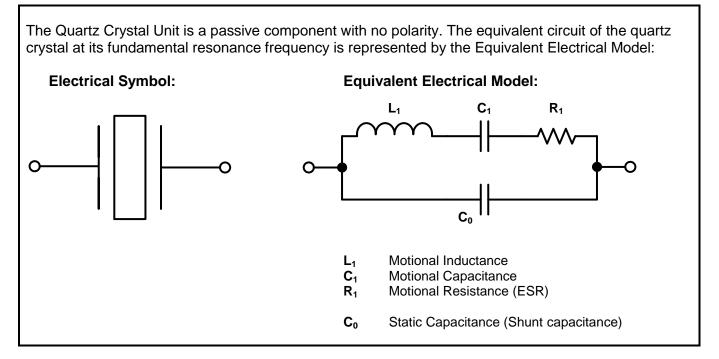
Example: CC1A-T1AH 24.000 MHz CL: 20.0 pF -50/+50ppm TD QI

Code	Operating temperature range
TD	-55 to +175°C
TG	-55 to +200°C

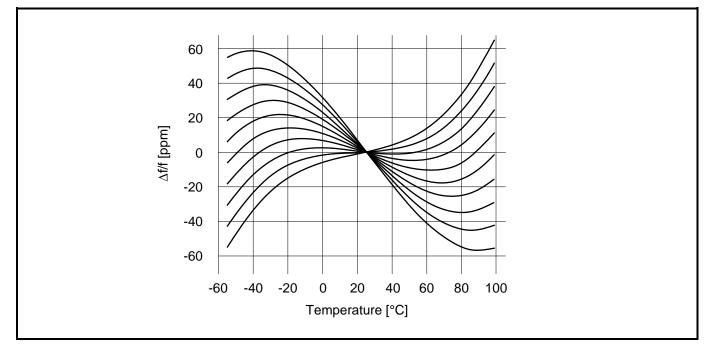
Code	Qualification
QI (Standard)	Industrial Grade
QS	Custom Specification

3. Electrical Characteristics

3.1. Equivalent Electrical Model

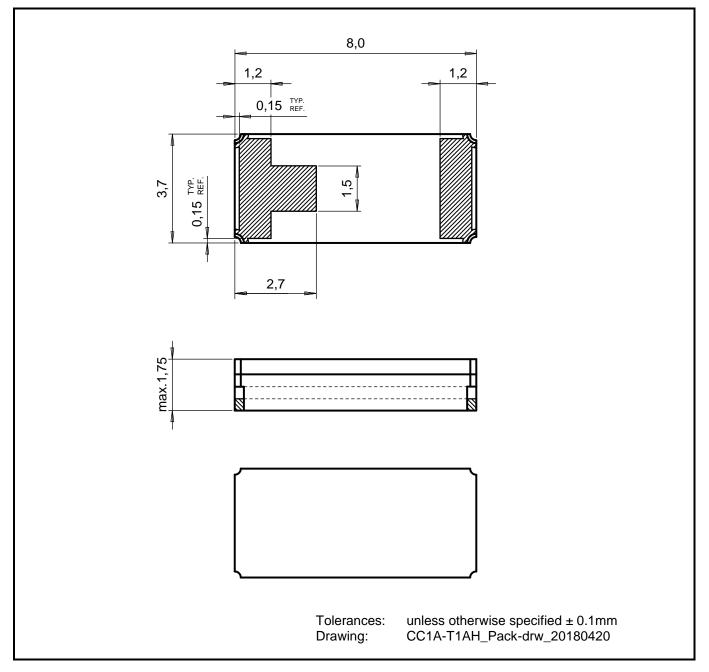


3.2. Frequency vs Temperature Characteristics

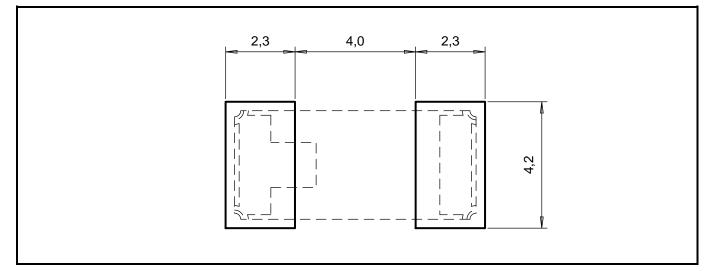


4. Mechanical Properties

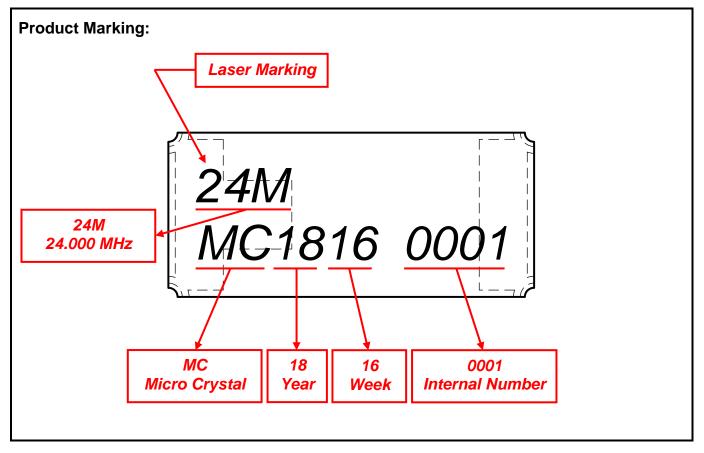
4.1. Package Dimension



4.2. Recommended Solderpad Layout



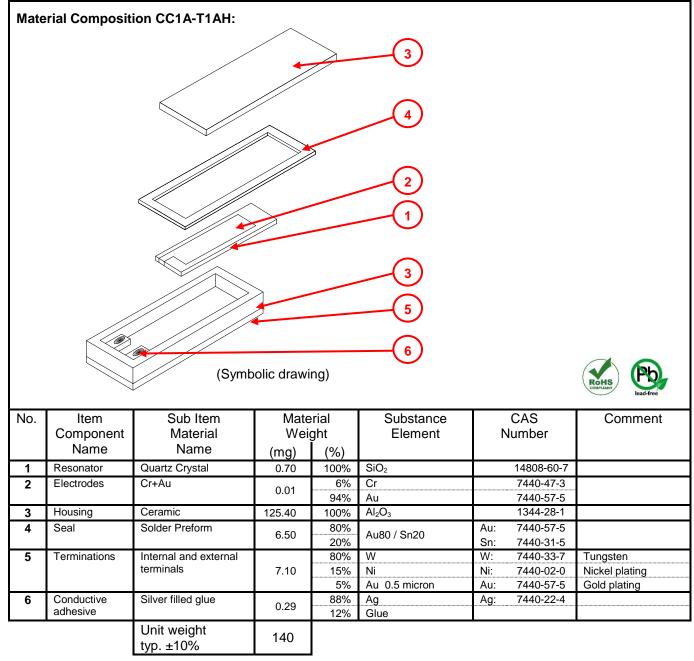
4.3. Product Marking



5. Material Composition Declaration & Environmental Information

5.1. Homogenous Material Composition Declaration

Homogenous material information according to IPC-1752 standard



CC1A-T1AH up to 200°C

5.2. Material Analysis & Test Results

Homogenous material information according to IPC-1752 standard

No.	No. Item Sub Item Component Material		RoHS					Halogen			Phthalates					
	Name	Name		Cd	Нg	Cr+6	PBB	PBDE	Ц	CI	Br	_	BBP	DBP	DEHP	DINP
1	Resonator	Quartz Crystal	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
2	Electrodes	Cr+Au	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
3	Housing	Ceramic	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
4	Seal	Solder Preform	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
5	Terminations	Int. & ext. terminals	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
6	Conductive adhesive	Silver filled glue	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
	MDL	Measurement Detection Limit		2 ppm 5 ppm		50 ppm				0.003%			0.01%			
		-	nd = not detectable					able								

Test methods: RoHS

Halogen

Phthalates

Test method with reference to IEC 62321-5: 2013 Test method with reference to BS EN 14582:2007 Test method with reference to EN 14372 MDL: 2 ppm (PBB / PBDE: 5 ppm)

MDL: 50 ppm

MDL: 0.003 % (DINP 0.01%)

5.3. Recycling Material Information

Recycling material information according to IPC-1752 standard.

ltem Material	No.	Item Component	Material Weight		Substance Element	CAS Number	Comment
Name		Name	(mg)	(%)			
Quartz Crystal	1	Resonator	0.70	0.50	SiO ₂	14808-60-7	
Chromium	2	Electrodes	0.0006	0.0004	Cr	7440-47-3	
Ceramic	3	Housing	125.40	89.57	AI_2O_3	1344-28-1	
Gold	2 4 5	Electrodes Seal Terminations	5.56	3.97	Au	7440-57-5	
Tin	4	Seal	1.30	0.93	Sn	Sn: 7440-31-5	
Nickel	5	Terminations	1.07	0.76	Ni	Ni: 7440-02-0	
Tungsten	5	Terminations	5.68	4.06	W	W: 7440-33-7	
Silver	6a	Conductive adhesive	0.26	0.18	Ag	Ag: 7440-22-4	
Glue	6b	Conductive adhesive	0.035	0.025	Glue		
	Unit v typ. ±	weight (total) 10%	140	100			

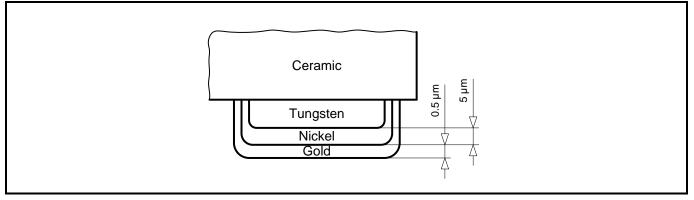
available on request

5.4. Environmental Properties & Absolute Maximum Ratings

Package	Description					
Ceramic Package	Hermetic ceramic-package, no-leads					
Parameter	Directive	Conditions	Value			
Product weight (total)			140 mg			
Storage temperature	MIL-O-55310	Store as bare product	-55 to +125°C			
Moisture sensitivity level (MSL)	IPC/JEDEC J-STD-020D		MSL 1			

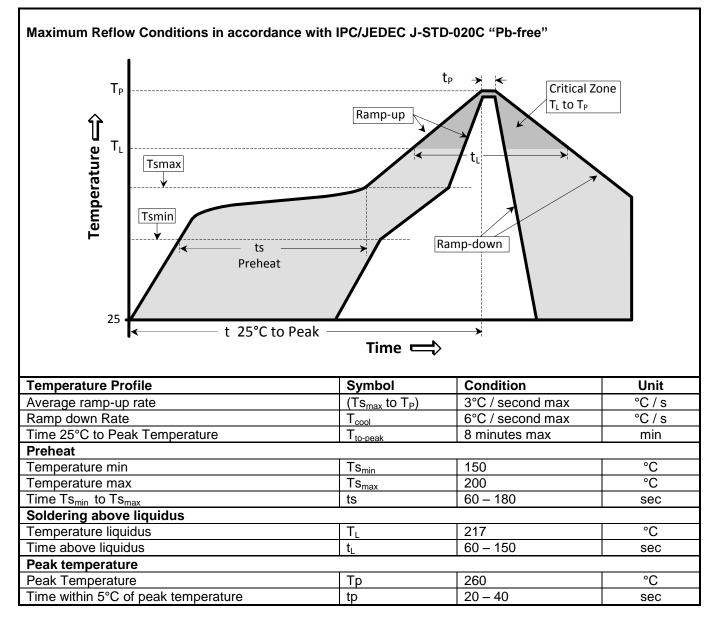
Terminal finish:

FIT / MTBF



6. Application Information

6.1. Soldering Information



6.2. Handling Instructions for Quartz Crystal Units

The built-in AT-cut crystal consists of pure Silicon Dioxide in crystalline form. The cavity inside the package is evacuated and hermetically sealed in order for the crystal blank to function undisturbed from air molecules, humidity and other influences.

Shock and vibration:

Keep the crystal / module from being exposed to **excessive mechanical shock and vibration**. Micro Crystal guarantees that the crystal / module will bear a mechanical shock of 5000 g / 0.3 ms.

The following special situations may generate either shock or vibration:

Multiple PCB panels - Usually at the end of the pick & place process the single PCBs are cut out with a router. These machines sometimes generate vibrations on the PCB that have a fundamental or harmonic frequency close to the resonance frequency of the crystal unit. This might cause breakage of crystal blanks due to resonance. Router speed should be adjusted to avoid resonant vibration.

Ultrasonic cleaning - Avoid cleaning processes using ultrasonic energy. These processes can damage crystals due to mechanical resonance of the crystal blank.

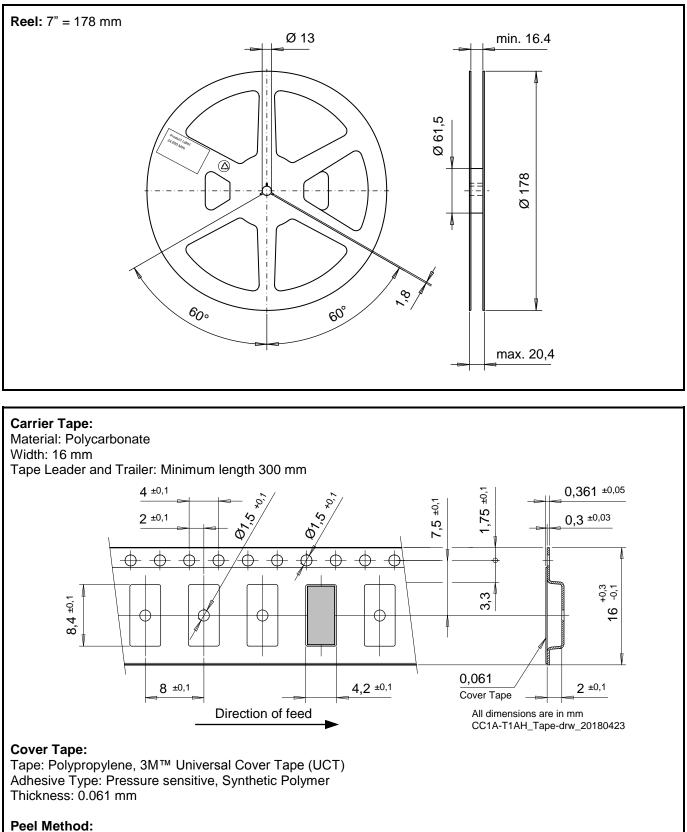
Overheating, rework high temperature exposure:

Avoid overheating the package. The package is sealed with a seal ring consisting of 80% Gold and 20% Tin. The eutectic melting temperature of this alloy is at 280°C. Heating the seal ring up to >280°C will cause melting of the metal seal which then, due to the vacuum, is sucked into the cavity forming an air duct. This happens when using hot-air-gun set at temperatures >300°C.

Use the following methods for rework:

- Use a hot-air- gun set at 270°C.
- Use 2 temperature controlled soldering irons, set at 270°C, with special-tips to contact all solder-joints from both sides of the package at the same time,

7. Packing & Shipping Information



Medial section removal, both lateral stripes remain on carrier

8. Compliance Information

Micro Crystal confirms that the standard product Quartz Crystal Unit CC1A-T1AH is compliant with "EU RoHS Directive" and "EU REACh Directives".

Please find the actual Certificate of Conformance for Environmental Regulations on our website: <u>CoC_Environment_CC&CM-Series.pdf</u>

9. Document Revision History

Date	Revision #	Revision Details
April 2018	1.0	First release

Information furnished is believed to be accurate and reliable. However, Micro Crystal assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. In accordance with our policy of continuous development and improvement, Micro Crystal reserves the right to modify specifications mentioned in this publication without prior notice. This product is not authorized for use as critical component in life support devices or systems.



Micro Crystal AG Muehlestrasse 14 CH-2540 Grenchen Switzerland Phone +41 32 655 82 82 Fax +41 32 655 82 83 sales@microcrystal.com www.microcrystal.com